

Federal Communications Commission
Authorization and Evaluation Division
7435 Oakland Mills Rd.
Columbia, MD. 21046

Date: March 10, 2000

Attention: Authorization and Evaluation Division

Subject: RFI related modifications incorporated into unit with
COLOR MONITOR -- FCC ID: AMPJ41C

Dear Sirs:

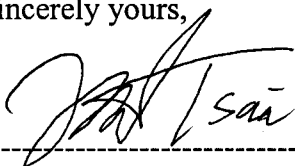
This letter serves as our declaration that all modifications listed below were implemented in the sample submitted for testing. We further declare that the same modifications will be implemented into all production units to enhance compliance of the units to FCC limits.

The modifications include the following:

- 1) Added a ferrite core on the video cable outside the monitor (see photo 2)
- 2) Added a metal cover on the solder side of CRT board and it was connected to chassis by seven ground wires. (see photo 5 & 6)
- 3) Added five capacitors, two resistors, and one bead core on the solder side of main board for EMI. They will be built into the component side after circuit re-layout. (see photo 9)

If you have any further questions or comments regarding the above, please don't hesitate to contact Mr. Mike Su of ADT Lab. at fax No.: 886-2-2602-2943 or E-mail: mike@mail.adt.com.tw

Sincerely yours,



Kent Tsai / Safety Manager
Jean Co., Ltd.

Cc. Mr. Harris W. Lai - Advance Data Technology Corporation

Federal Communications Commission
Authorization and Evaluation Division
7435 Oakland Mills Rd.
Columbia, MD. 21046

Date: March 10, 2000

Attention: Authorization and Evaluation Division

Subject: RFI related modifications incorporated into unit with
COLOR MONITOR -- FCC ID: AMPJ51I

Dear Sirs:

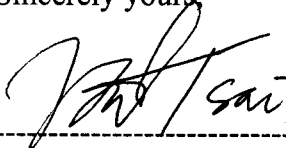
This letter serves as our declaration that all modifications listed below were implemented in the sample submitted for testing. We further declare that the same modifications will be implemented into all production units to enhance compliance of the units to FCC limits.

The modifications include the following:

- 1) Added a ferrite core on the video cable outside the monitor (see photo 2)
- 2) Added a metal cover on the solder side of CRT board and it was connected to chassis by two ground wires. (see photo 5 & 6)
- 3) Added 2 capacitors, 1 resistors, 1 bead core and 1 jump wire on the solder side of main board for EMI. They will be built into the component side after circuit re-layout. (see photo 9)

If you have any further questions or comments regarding the above, please don't hesitate to contact Mr. Mike Su of ADT Lab. at fax No.: 886-2-2602-2943 or E-mail: mike@mail.adt.com.tw

Sincerely yours



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